

FMP12N50ES

FUJI POWER MOSFET

Super FAP-E^{3S} series

N-CHANNEL SILICON POWER MOSFET

■ Features

Maintains both low power loss and low noise Lower R_{DS}(on) characteristic More controllable switching dv/dt by gate resistance Smaller V_{GS} ringing waveform during switching Narrow band of the gate threshold voltage (3.7±0.5V) High avalanche durability

Applications

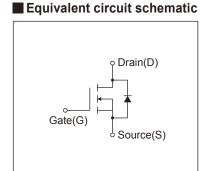
Switching regulators UPS (Uninterruptible Power Supply) DC-DC converters

Maximum Ratings and Characteristics

● Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

TO-220AB \$3.6 m. ∂ee Note:1. 0.4 %2 0.8% 000

■ Outline Drawings [mm]



Description	Symbol	Characteristics	Unit	Remarks
Dunin Sauraa Valtana	V _{DS}	500	V	
Drain-Source Voltage	V _{DSX}	500	V	V _{GS} = -30V
Continuous Drain Current	ID	±12	А	
Pulsed Drain Current	IDP	±48	Α	
Gate-Source Voltage	V _G s	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	Iar	12	Α	Note*1
Non-Repetitive Maximum Avalanche Energy	Eas	460.8	mJ	Note*2
Repetitive Maximum Avalanche Energy	Ear	18.0	mJ	Note*3
Peak Diode Recovery dV/dt	dV/dt	6.3	kV/μs	Note*4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5
Maximum Power Dissipation	PD	2.02	W	Ta=25°C
		180	VV	Tc=25°C
Operating and Storage Temperature range	Tch	150	°C	
	Tstg	-55 to + 150	°C	

● Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit	
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V		500	-	-	V	
Gate Threshold Voltage	V _{GS} (th)	I _D =250µA, V _{DS} =V _{GS}		3.2	3.7	4.2	V	
Zero Gate Voltage Drain Current		V _{DS} =500V, V _{GS} =0V	T _{ch} =25°C	-	-	25		
	IDSS	V _{DS} =400V, V _{GS} =0V	Tch=125°C	-	-	250	μA	
Gate-Source Leakage Current	Igss	V _{GS} =±30V, V _{DS} =0V		-	10	100	nA	
Drain-Source On-State Resistance	Ros (on)	I _D =6A, V _{GS} =10V		-	0.427	0.50	Ω	
Forward Transconductance	g _{fs}	I _D =6A, V _{DS} =25V		4.5	9	-	S	
Input Capacitance	Ciss	V _{DS} =25V V _{GS} =0V f=1MHz		-	1400	2100	pF	
Output Capacitance	Coss			-	160	240		
Reverse Transfer Capacitance	Crss			-	11.5	17.5		
Turn-On Time	td(on)	V_{cc} =300V V_{GS} =10V I_{D} =6A R_{G} =15 Ω		-	31	46.5	ns	
	tr			-	18	27		
Turn-Off Time	td(off)			-	83	124.5		
	tf			-	16	27		
Total Gate Charge	Q _G	V _{cc} =250V I _D =12A V _{GS} =10V		-	43	56	nC	
Gate-Source Charge	Qgs			-	13	23		
Gate-Drain Charge	Q _{GD}			-	14	21		
Gate-Drain Crossover Charge	Qsw			-	6	10		
Avalanche Capability	lav	L=2.44mH, Tch=25°C		12	-	-	Α	
Diode Forward On-Voltage	V _{SD}	I _F =12A, V _{GS} =0V, T _{ch} =25°C		-	0.86	1.30	V	
Reverse Recovery Time	trr	I _F =12A, V _{GS} =0V		-	0.37	-	μs	
Reverse Recovery Charge	Qrr	-di/dt=100A/µs, Tch=25°C		-	5.0	-	μC	

Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to Case			0.690	°C/W
	Rth (ch-a)	Channel to Ambient			62.0	°C/W

Note *1 : Tch≤150°C.

Note *2 : Stating Tch=25°C, IAs=5A, L=33.8mH, Vcc=60V, R_G=50Ω.

EAS limited by maximum channel temperature and avalanche current.

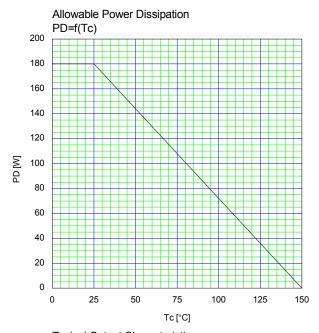
See to 'Avalanche Energy' graph.

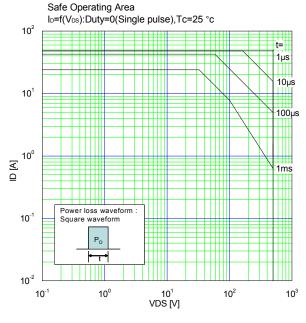
Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature. See to the 'Transient Themal impeadance' graph.

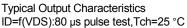
Note *4 : IF≤-ID, -di/dt=100A/µs, Vcc≤BVDSS, Tch≤150°C

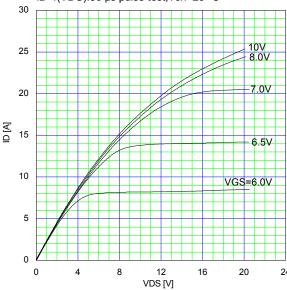
Note *5 : IF≤-ID, dv/dt=6.3kV/µs, Vcc≤BVDss, Tch≤150°C

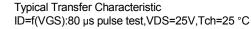
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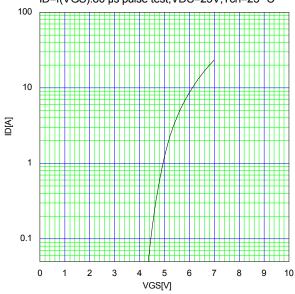




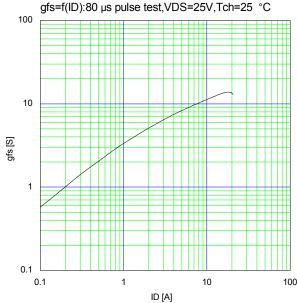




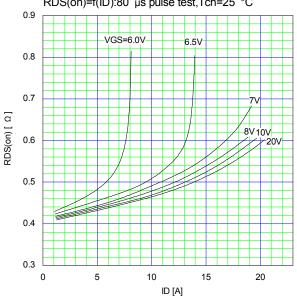




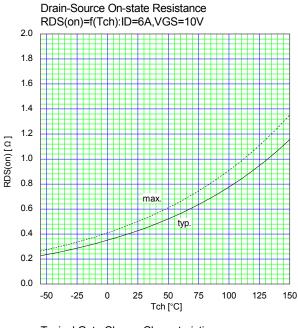
Typical Transconductance gfs=f(ID):80 µs pulse test,VDS=25V,Tch=25 °C

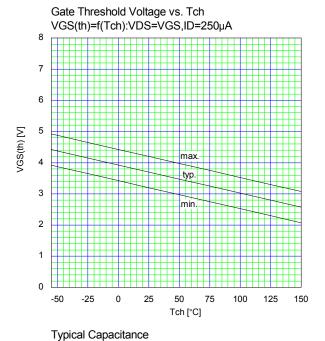


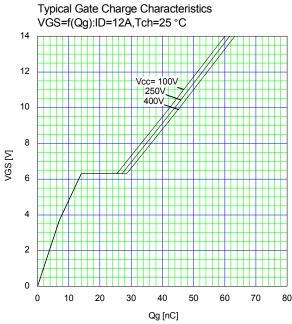
Typical Drain-Source on-state Resistance RDS(on)=f(ID):80 μ s pulse test,Tch=25 $^{\circ}$ C

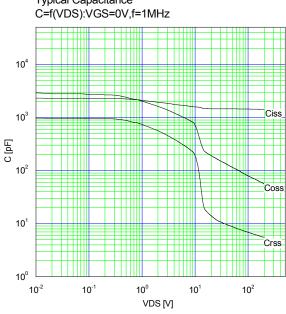


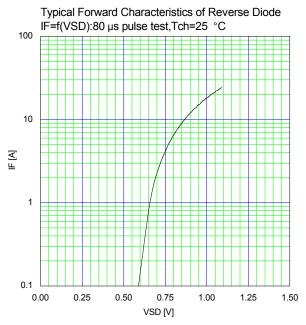
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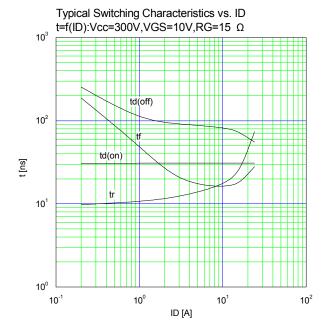


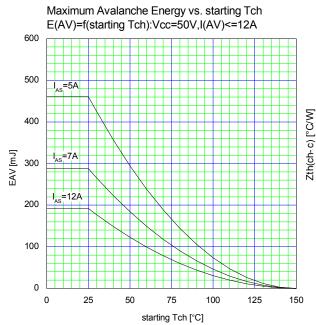


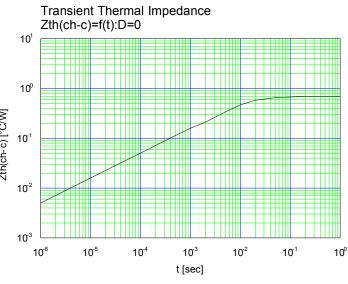












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